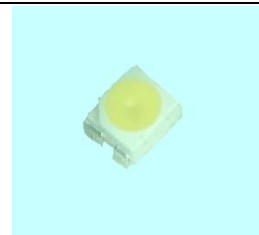
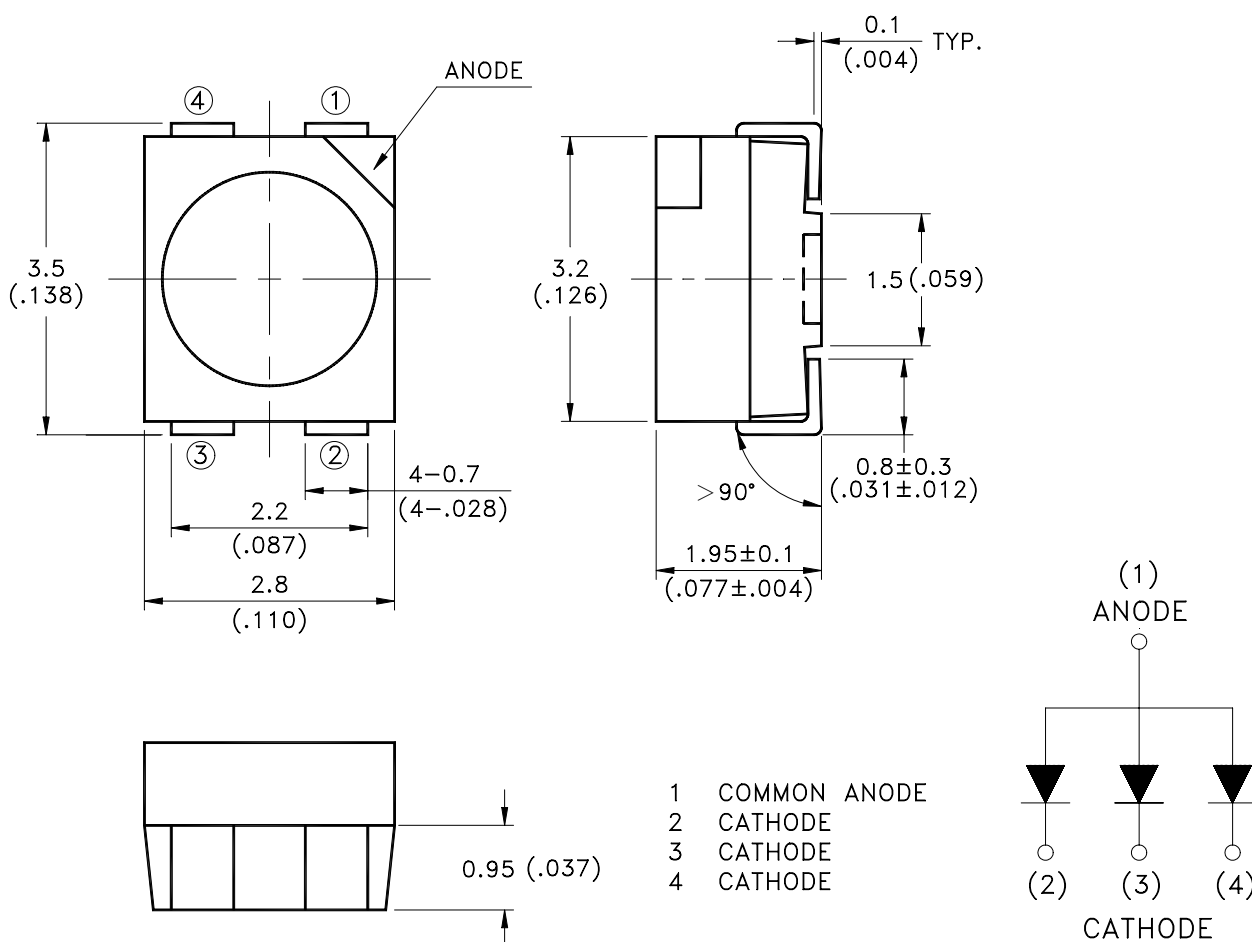


Features

- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic placement equipment.
- * Compatible with infrared and vapor phase reflow solder process.
- * EIA STD package.
- * I.C. compatible.
- * Lead Free Package(According to RoHS)



Package Dimensions



Part No.	Lens Color	Source Color
LTW-673DT	Yellow	InGaN White

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.2 mm (.008") unless otherwise noted.

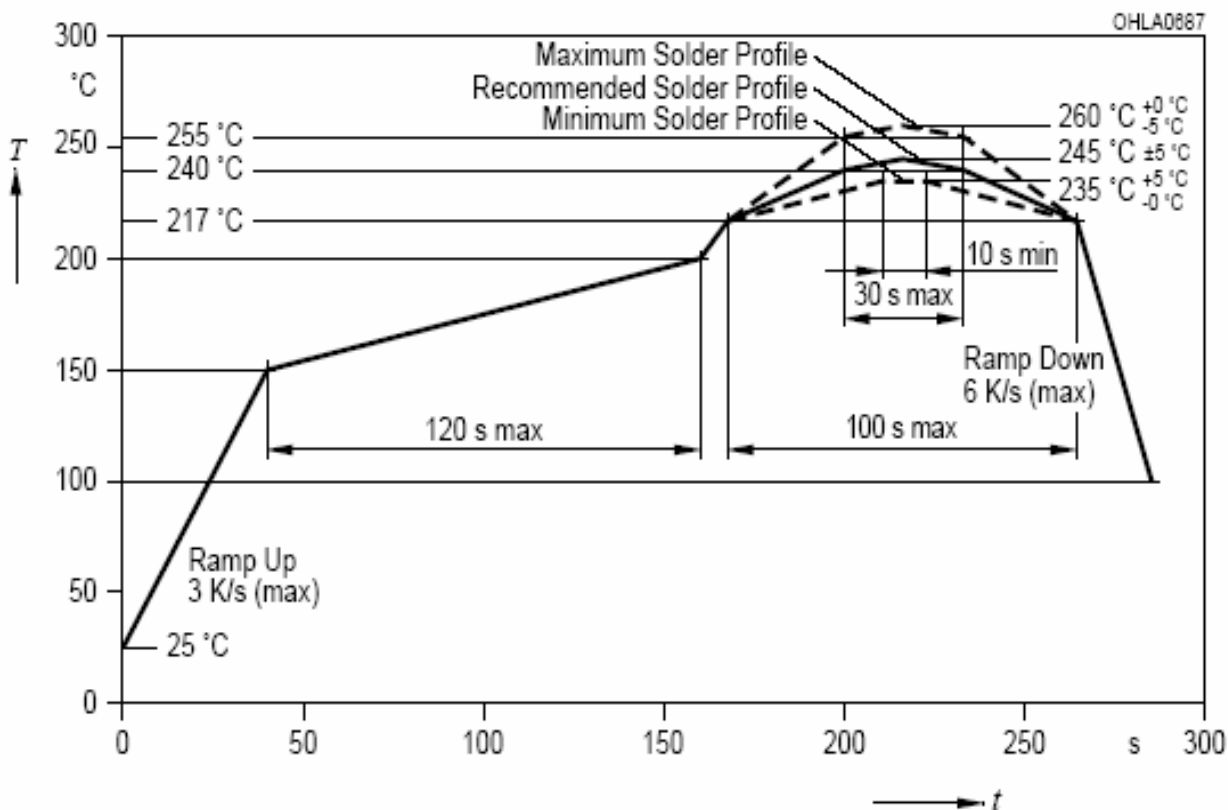
Property of Lite-On Only

Absolute Maximum Ratings at Ta=25°C

Parameter	LTW-673DT	Unit
Power Dissipation	351	mW
Peak Pulse Current (per die) (Tw ≤ 300ms, Duty ratio ≤ 1/10)	100	mA
DC Forward Current	90	mA
Reverse Voltage	5	V
Operating Temperature Range	-30°C to + 85°C	
Storage Temperature Range	-40°C to + 100°C	
Wave Soldering Condition	260°C For 5 Seconds	

Suggest IR Reflow Condition :

IR-Reflow Soldering Profile for lead free soldering (Acc. to J-STD-020B)



Property of Lite-On Only

Electrical Optical Characteristics At Ta=25°C

Parameter	Symbol	Part No. LTW-	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	I_V	673DT	2800	3700	4500	mcd	$I_F = 60\text{mA}$ 20mA / die
				5200			$I_F = 90\text{mA}$ 30mA / die
Luminous Flux	Φ_V	673DT		11000		mlm	$I_F = 60\text{mA}$ 20mA / die
				14500		mlm	$I_F = 90\text{mA}$ 30mA / die
Viewing Angle	2θ 1/2	673DT		120		deg	Fig.6
Chromaticity Coordinates	x	673DT		0.32			$I_F = 60\text{mA}$ Note 3, 5, 6 Fig.1
	y			0.31			
Forward Voltage (per die)	V_F	673DT	3.0	3.4	3.9	V	$I_F = 20\text{mA}$
Reverse Current (per die)	I_R	673DT			100	μA	$V_R = 5\text{V}$

Note :

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- I_V classification code is marked on each packing bag.
- The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.
- Caution in ESD:
Static Electricity and surge damages the LED. It is recommended using a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- The chromaticity coordinates (x, y) guarantee should be added ± 0.02 tolerance.

Property of Lite-On Only

Bin Code List

IV Spec. Table

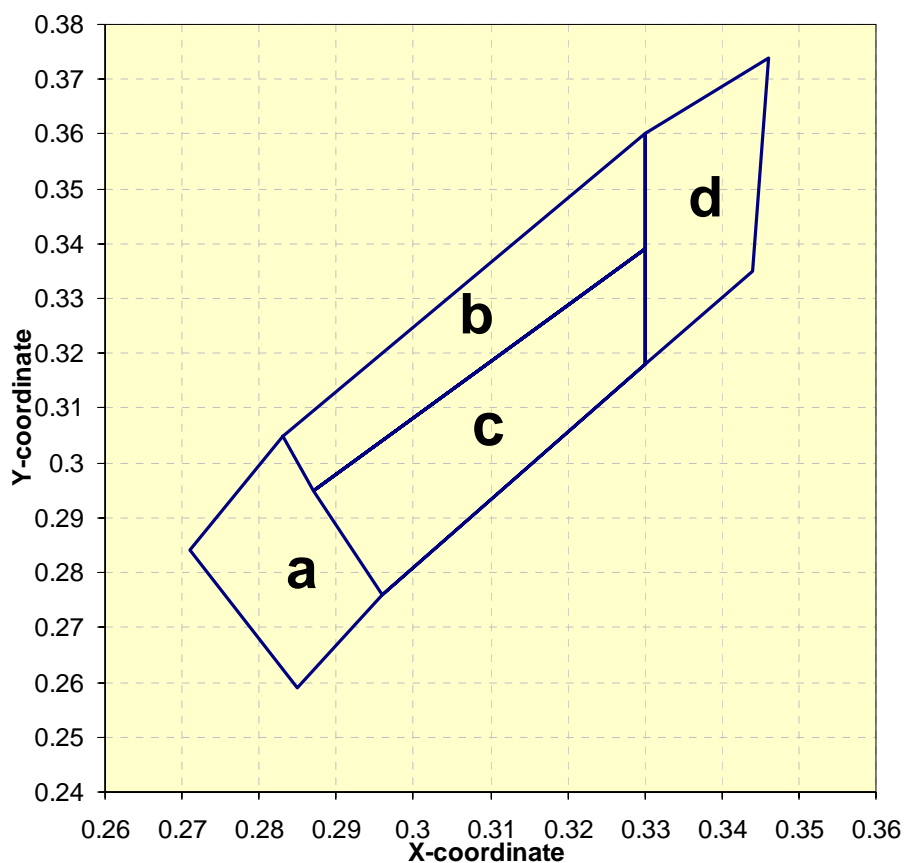
IV Bin	Luminous Intensity (mcd) at $I_F = 60\text{mA}$, 20mA / die		Luminous Flux (lm)
	Min.	Max.	Typ.
Y1	2800	3550	8000
Y2	3550	4500	11000

Tolerance on each Luminous Intensity bin is +/- 15%.

Hue Spec. Table

Hue Bin	Color bin limits at $I_F = 60\text{mA}$, 20mA / die				
	CIE 1931 Chromaticity coordinates				
a	x	0.271	0.285	0.296	0.283
	y	0.284	0.259	0.276	0.305
b	x	0.283	0.287	0.330	0.330
	y	0.305	0.295	0.339	0.360
c	x	0.287	0.296	0.330	0.330
	y	0.295	0.276	0.318	0.339
d	x	0.330	0.330	0.344	0.346
	y	0.360	0.318	0.335	0.374

Tolerance on each Hue (x, y) bin is +/- 0.02



Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)

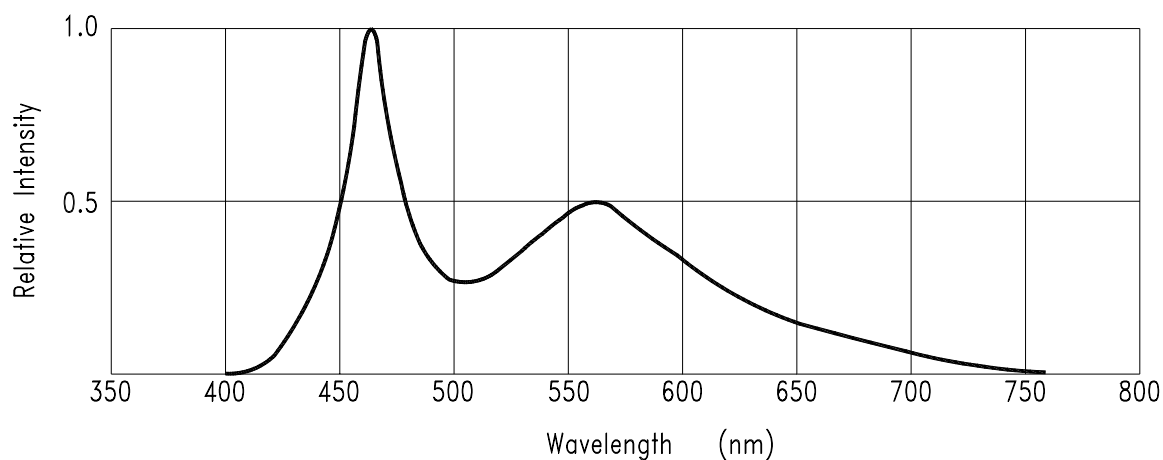


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

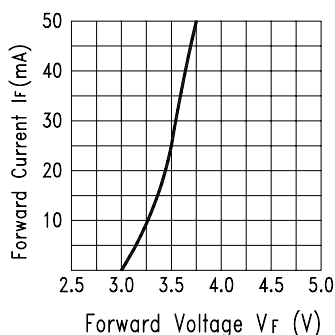


Fig.2 Forward Current vs.
Forward Voltage

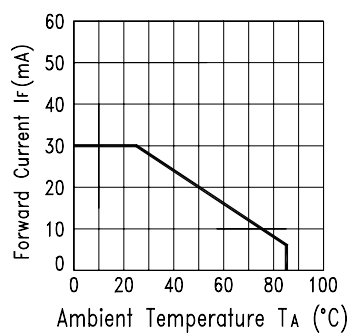


Fig.3 Forward Current
Derating Curve

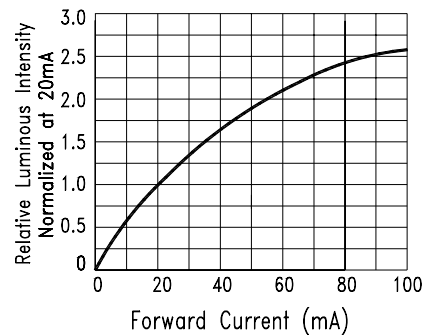


Fig.4 Relative Luminous Intensity
vs. Forward Current

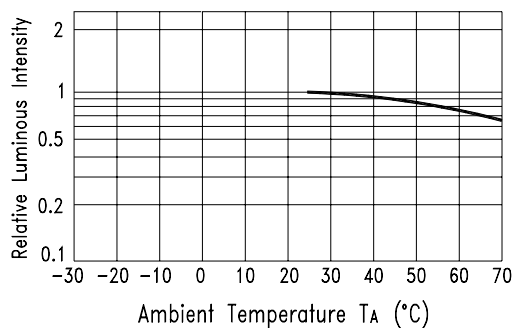


Fig.5 Luminous Intensity vs.
Ambient Temperature

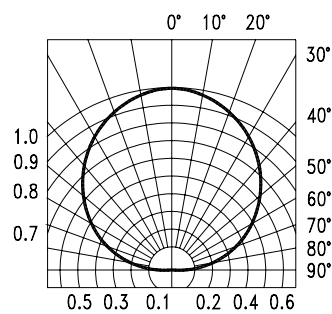


Fig.6 Spatial Distribution

Property of Lite-On Only

User Guide

Cleaning

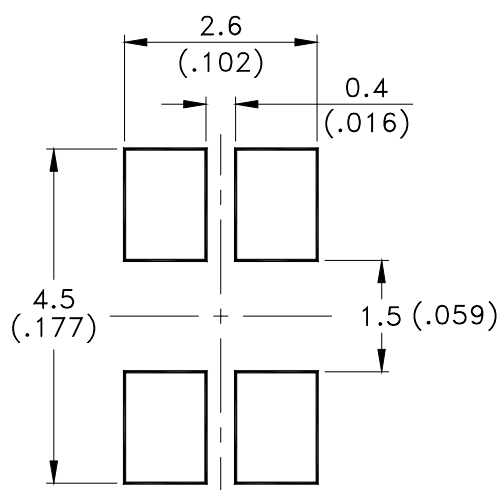
Do not use unspecified chemical liquid to clean LED they could harm the package.

If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less than one minute.

Recommend Printed Circuit Board Attachment Pad

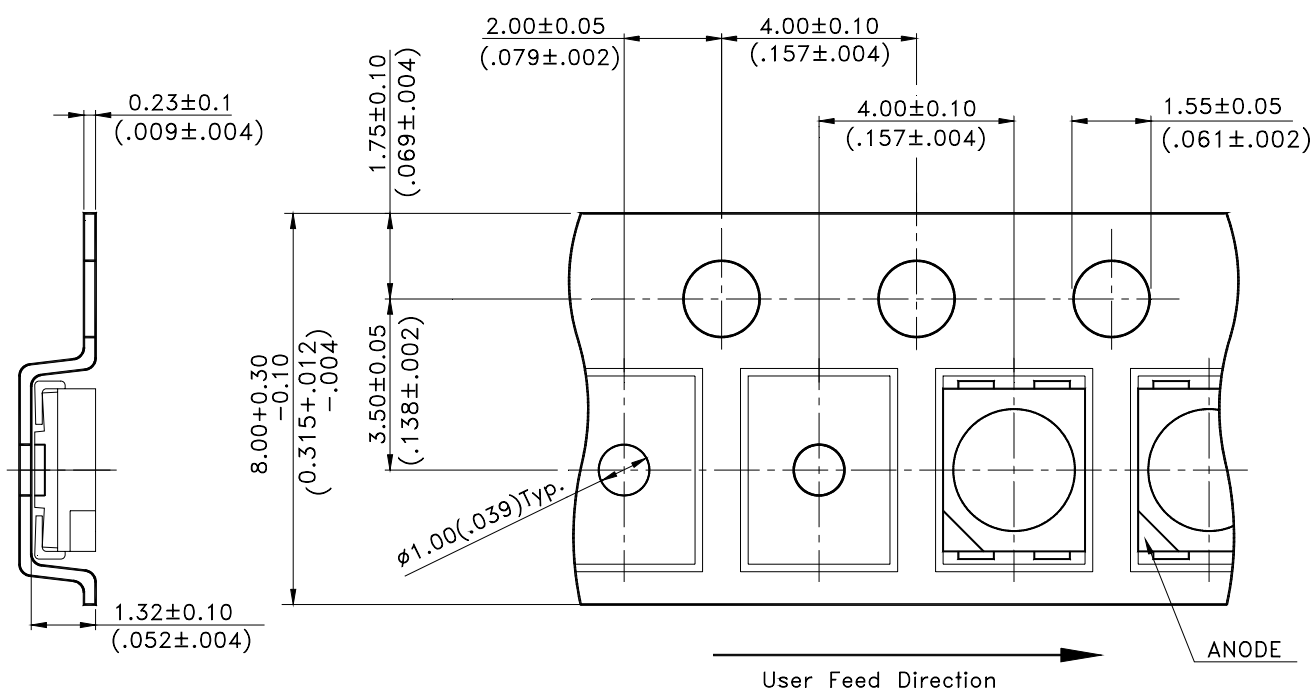
Infrared / vapor phase

Reflow Soldering

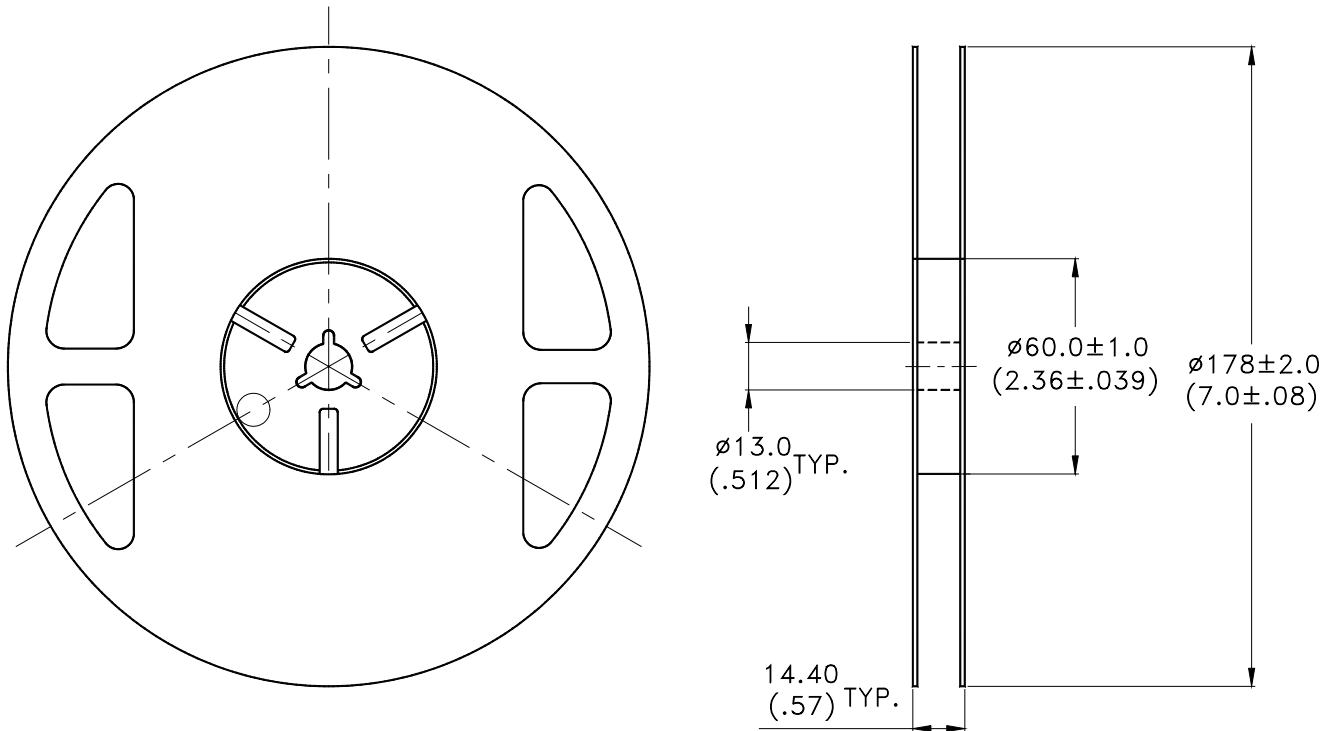


Package Dimensions of Tape

Note:



Package Dimensions of Reel



Notes:

1. Empty component pockets sealed with top cover tape.
2. 7 inch reel-2000 pieces per reel.
3. Minimum packing quantity is 500 pieces for remainders.
4. The maximum number of consecutive missing lamps is two.
5. In accordance with EIA-481-1-B specifications.

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 85°C temperature or 60% relative humidity.

It is recommended that LEDs out of their original packaging are IR-reflowed within one week.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.

LEDs stored out of their original packaging for more than a week should be baked at about 60 deg C for at least 24 hours before solder assembly.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

4. Soldering

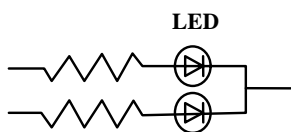
Recommended soldering conditions:

Reflow soldering		Wave Soldering		Soldering iron	
Pre-heat	120~150°C	Pre-heat	100°C Max.	Temperature	300°C Max.
Pre-heat time	120 sec. Max.	Pre-heat time	60 sec. Max.	Soldering time	3 sec. Max.
Soldering Temp.	260°C Max.	Solder wave	260°C Max.		(one time only)
Soldering time	30 sec. Max.	Soldering time	10 sec. Max.		

5. Drive Method

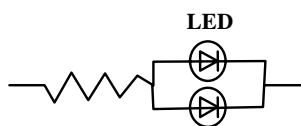
An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



(A) Recommended circuit.

Circuit model B



(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

Property of Lite-On Only

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or “no light up” at low currents.

To verify for ESD damage, check for “light up” and Vf of the suspect LEDs at low currents.

The Vf of “good” LEDs should be $>2.0V@0.1mA$ for InGaN product and $>1.4V@0.1mA$ for AlInGaP product.

7. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= $65\pm5^{\circ}C$, RH= 90~95% *Test Time= 240HRS \pm 2HRS	MIL-STD-202F:103B JIS C 7021:B-11
	High Temperature Storage	Ta= $105\pm5^{\circ}C$ *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
	Low Temperature Storage	Ta= $-55\pm5^{\circ}C$ *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12
Environmental Test	Temperature Cycling	$105^{\circ}C \sim 25^{\circ}C \sim -55^{\circ}C \sim 25^{\circ}C$ 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
	Thermal Shock	IR-Reflow In-Board, 2 Times $85\pm5^{\circ}C \sim -40^{\circ}C \pm 5^{\circ}C$ 10mins 10mins 100 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
	IR-Reflow	Ramp-up rate($217^{\circ}C$ to Peak) $+3^{\circ}C$ / second max Temp. maintain at $175(\pm 25)^{\circ}C$ 180 seconds max Temp. maintain above $217^{\circ}C$ 60-150 seconds Peak temperature range $260^{\circ}C +0/-5^{\circ}C$ Time within $5^{\circ}C$ of actual Peak Temperature (tp) 20-40 seconds Ramp-down rate $+6^{\circ}C$ /second max	MIL-STD-750D:2031.2 J-STD-020B(2002)
	Solderability	T.sol= $235\pm5^{\circ}C$ Immersion time 2 ± 0.5 sec Immersion rate 25 ± 2.5 mm/sec Coverage $\geq 95\%$ of the dipped surface	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

9. Quality Guarantee

LiteOn guarantee DPPM level of function failure is smaller and equal to 50 DPPM.

(Based on 100k usage)

10. Suggested Checking List**Training and Certification**

1. Everyone working in a static-safe area is ESD-certified?
2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

1. Static-safe workstation or work-areas have ESD signs?
2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
3. All ionizer activated, positioned towards the units?
4. Each work surface mats grounding is good?

Personnel Grounding

1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
2. If conductive footwear used, conductive flooring also present where operator stand or walk?
3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
5. All wrist strap or heel strap checkers calibration up to date?

Note: *50V for Blue LED.

Device Handling

1. Every ESDS items identified by EIA-471 labels on item or packaging?
2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

1. Audit result reported to entity ESD control coordinator?
2. Corrective action from previous audits completed?
3. Are audit records complete and on file?